

DATA SHEET

TDA1576T **FM-IF amplifier/demodulator circuit**

Preliminary specification
File under Integrated Circuits, IC01

February 1991

FM-IF amplifier/demodulator circuit**TDA1576T****FEATURES**

- Fully balanced 4-stage limiting IF amplifier
- Symmetrical quadrature demodulator
- Field-strength indication output for 1 mA ammeter
- Detune detector for side response and noise attenuation
- Detune voltage output
- Internal muting circuit
- 0° and 180° AF output signals
- Reference voltage output
- Electronic smoothing of the supply voltage.

GENERAL DESCRIPTION

The TDA1576T is a monolithic integrated FM-IF amplifier circuit for use in mono and stereo FM-receivers of car radios or home sets.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_P	supply voltage (pin 1)		7.5	8.5	15	V
I_P	supply current		10	16	23	mA
$V_{iIF(rms)}$	input sensitivity (RMS value)	-3 dB before limiting	14	22	35	μ V
		S/N = 26 dB	-	10	-	μ V
		S/N = 46 dB	-	55	-	μ V
$V_{oAF(rms)}$	AF output signal voltage (RMS value)		-	67	-	mV
THD	total harmonic distortion with double resonant circuits		-	0.02	-	%
S/N	signal-to-noise ratio	$V_i > 1$ mV	-	72	-	dB
α_{AM}	AM suppression		-	50	-	dB
RR	ripple rejection	$f = 100$ Hz	43	48	-	dB
I_{15}	maximum indicator output current		-	-	2	mA
T_{amb}	operating ambient temperature		-30	-	+80	°C

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
TDA1576T	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1

FM-IF amplifier/demodulator circuit

TDA1576T

BLOCK DIAGRAM

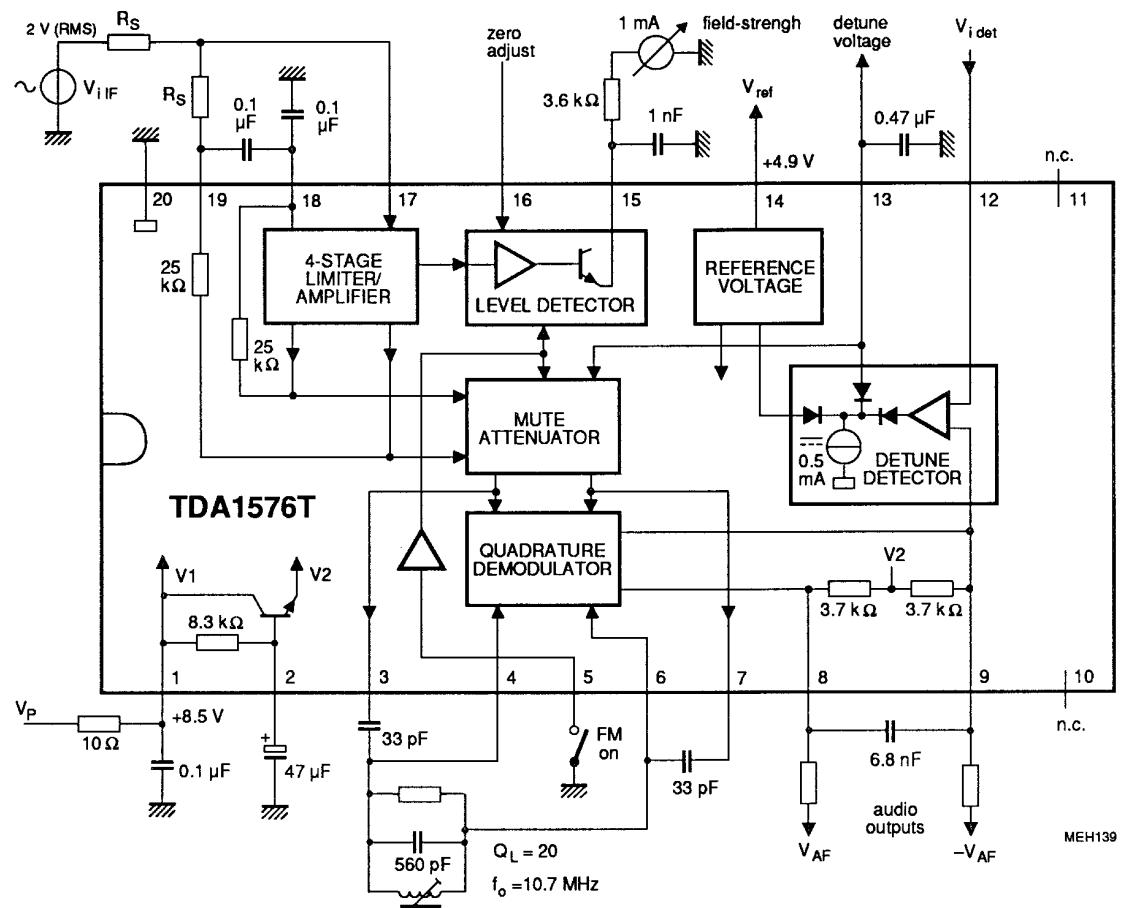


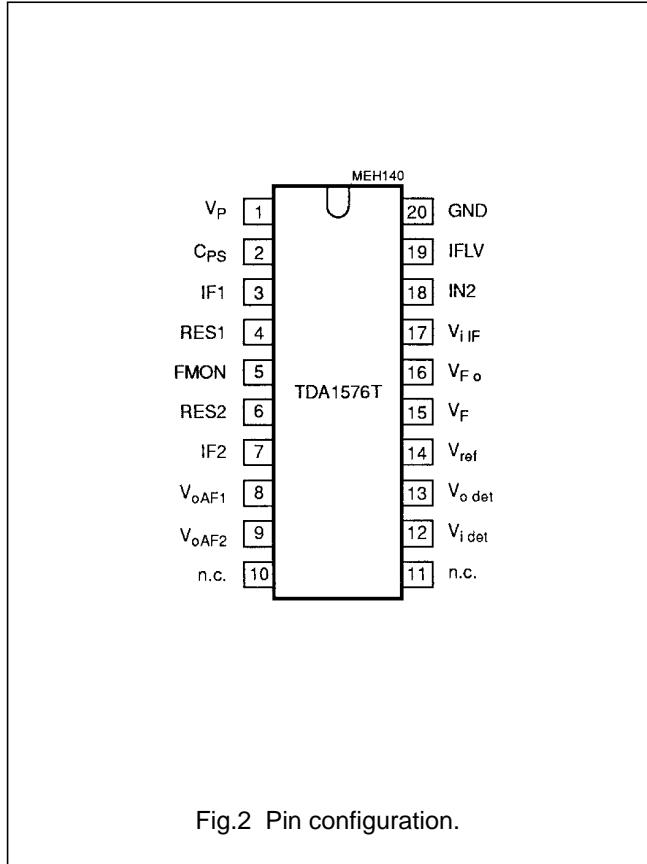
Fig.1 Block diagram.

FM-IF amplifier/demodulator circuit

TDA1576T

PINNING

SYMBOL	PIN	DESCRIPTION
V _P	1	positive supply voltage
C _{PS}	2	smoothing capacitor of power supply
IF1	3	IF signal to resonant circuit
RES1	4	resonant circuit
FMON	5	FM-ON, standby switch
RES2	6	resonant circuit
IF2	7	IF signal to resonant circuit
V _{oAF1}	8	AF output voltage (0° phase)
V _{oAF2}	9	AF output voltage (180° phase)
n.c.	10	not connected
n.c.	11	not connected
V _{i det}	12	detune detector input voltage for external audio reference
V _{o det}	13	detune detector output voltage
V _{ref}	14	reference voltage output
V _F	15	level output for field-strength
V _{F o}	16	zero adjust voltage for field-strength
V _{i IF}	17	FM-IF input signal
IN2	18	input 2 of differential IF amplifier
IFLV	19	IF input level
GND	20	ground (0 V)



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _P	supply voltage (pin 1)	0	15	V
V _{2, 5, 16}	voltage on pins 2, 5 and 16	0	V _P	V
P _{tot}	total power dissipation	0	450	mW
T _{stg}	storage temperature	-55	+150	°C
T _{amb}	operating ambient temperature range	-30	+85	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient in free air	85	K/W

FM-IF amplifier/demodulator circuit

TDA1576T

CHARACTERISTICS

$V_P = 8.5 \text{ V}$; $f_{iZF} = 10.7 \text{ MHz}$; $R_S = 60 \Omega$; $f_m = 400 \text{ Hz}$ with $\Delta f = \pm 22.5 \text{ kHz}$; $50 \mu\text{s}$ de-emphasis ($C_{8-9} = 6.8 \text{ nF}$); $T_{amb} = 25^\circ\text{C}$ and measurements taken in Fig.1; unless otherwise specified. The demodulator circuit is adjusted at minimum second harmonic distortion for $V_{iZF} = 1 \text{ mV}$ and a deviation $\Delta f = \pm 75 \text{ kHz}$.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_P	supply voltage (pin 1)		7.5	8.5	15	V
I_P	supply current	$V_5 = V_9 = V_{13} = 0$	10	16	23	mA
Reference voltage						
V_{ref}	reference voltage (pin 14)	$I_{14} = -1 \text{ mA}$	—	4.9	—	V
ΔV_{ref}	reference voltage dependence on temperature	$\frac{\Delta V_{14}}{V_{14} \times \Delta T}$	—	0.3	—	%/K
I_{14}	maximum output current	short-circuit current	4	6	7.5	mA
R_{14}	output resistor $\frac{\Delta V_{14}}{\Delta I_{14}}$	$I_{14} < 1.2 \text{ mA}$	—	60	150	Ω
IF amplifier						
V_{iIF}	input sensitivity (RMS value; pin 17)	-3 dB before limiting	14	22	35	μV
R_{17-18}	input resistance	$V_{iIF} = 200 \text{ mV}$ (RMS)	10	—	—	$\text{k}\Omega$
C_{17-18}	input capacitance	$V_{iIF} = 200 \text{ mV}$ (RMS)	—	5	—	pF
$V_{oIF(p-p)}$	output signal at pins 3 and 7 (peak-to-peak value)	$Z_{3,7} = 10 \text{ pF} // 1 \text{ M}\Omega$	610	680	750	mV
R_{3-7}	output resistance		200	250	300	Ω
Demodulator						
R_{4-6}	input resistance		20	30	40	$\text{k}\Omega$
C_{4-6}	input capacitance		—	1	2.5	pF
$R_{8,9}$	output resistance		2.9	3.7	4.5	$\text{k}\Omega$
$V_{8,9}$	DC offset voltage on output pins at $V_{4-6} = 0$	$V_5 > 3 \text{ V}$ or $V_{3-7} = 0$ or $V_{13} < 0.3 \text{ V}$	—	0	± 100	mV
$\frac{\Delta V}{\Delta \phi}$	demodulator efficiency	$\frac{\Delta V_{8-9}}{\Delta \phi}$	—	40	—	mV°
	demodulator efficiency dependent on supply voltage	K (note 1)	—	6.2	—	mV°
V/V	DC voltage ratio	$\frac{V_8 + V_9}{2V_2}$	0.653	0.667	0.680	V/V
$\frac{\Delta V}{\Delta T}$	dependence on temperature	$\frac{V_8 + V_9}{2V_2} \frac{1}{\Delta T}$	—	10^{-5}	—	$1/K$

FM-IF amplifier/demodulator circuit

TDA1576T

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Field-strength output; see Fig.4						
V ₁₅	output voltage	V _{IF} = 0	0	0.1	0.25	V
		V _{IF} = 1 mV (RMS)	1.1	1.5	1.9	V
		V _{IF} = 250 mV (RMS)	3.2	3.6	4.1	V
S	control steepness		—	0.85	—	V/dec
R ₁₅	output resistance		—	150	200	Ω
$\frac{\Delta V}{\Delta T}$	dependence on temperature	$V_{IF} = \frac{\Delta V_{15}}{\Delta T \times V_{15}}$	—	0.3	—	%/K
I ₁₅	standby operational cut-off current	V ₅ ≥ 3 V; V ₁₅ = 0 to 5 V	—	—	10	μA
Zero level adjustment						
V ₁₆	internal bias voltage		—	260	—	mV
R ₁₆	input resistance		—	19	—	kΩ
S	control steepness	V _{IF} = 100 mV; $A = \frac{\Delta V_{15}}{\Delta V_{16}}$	0.87	1.0	1.2	V/V
Detuning detector						
I ₁₂	input bias current		—	20	100	nA
R ₁₂	input resistance (Fig.5)	$\frac{5 \text{ V}}{\Delta I_{12}}$	6	30	—	MΩ
$\frac{V_{13}}{V_{14}}$	output voltage ratio for $\Delta\phi = \phi(\text{pins 3-7}) - \phi(\text{pins 4-6}) - 90^\circ$ $\Delta\phi = 9.2^\circ$ (43 kHz); Q = 20 $\Delta\phi = 3.5^\circ$ (16 kHz); Q = 20 $\Delta\phi = 14^\circ$ (65 kHz); Q = 20	V ₁ = V ₂ = 7.5 V; R ₁₃₋₁₄ = 10 kΩ; pins 9 and 12 short-circuit; see Fig.6				
		V _{9, 12} = 334 mV	0.45	0.5	0.55	V/V
		V _{9, 12} = 138 mV	0.75	0.8	0.85	V/V
		V _{9, 12} = 501 mV	0.335	0.345	0.355	V/V
I ₁₃	maximum output current	V ₁₃ = 6 V; see Fig.7	0.4	0.5	0.6	mA
	cut-off current	V ₁₃ = 2.5 V; V _{9, 12} = 0	—	—	-100	nA
Internal audio attenuation; see Fig.8						
$\frac{V_{13}}{V_{14}}$	output voltage ratio	$\alpha = \text{attenuation factor}$				
		$\alpha = 1 \text{ dB}$	0.11	0.12	0.13	
		$\alpha = 7.2 \text{ dB}$	0.095	0.1	0.105	
I ₁₃	input current	$\alpha \geq 40 \text{ dB}$	—	0.06	—	
		V ₁₃ / V ₁₃ ≤ 0.1 V	—	—	-225	nA

FM-IF amplifier/demodulator circuit

TDA1576T

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Standby switch; see Fig.9						
V_5	input voltage for FM-on	$V_{3,7} / V_{3,7(\max)} = 0.9;$ $V_{19} = 0.3 \text{ V}$	2.4	2.5	—	V
	input voltage for FM-off		—	2.9	3	V
	linear range		—	350	—	mV
I_5	input current	$V_5 = 0 \text{ to } 2 \text{ V}$	—	—	-100	μA
		$V_5 = 3.5 \text{ to } 15 \text{ V}$	—	—	1	μA
$\frac{V_5}{\Delta T}$	temperature dependence	FM-on ($3.5V_{BE}$)	—	7	—	mV/K
		FM-off ($5V_{BE}$)	—	10	—	mV/K
Supply voltage smoothing						
V_{1-2}	internal voltage drop	proportional to $V_1 - 3V_{BE}$	80	210	400	mV
R_{1-2}	internal resistor		5.8	8.3	10.8	$\text{k}\Omega$

Note to the characteristics

$$1. \quad V_{8-9} / \Delta\phi = K(V_P - 3V_{BE})$$

OPERATING CHARACTERISTICS

$V_P = 8.5 \text{ V}$; $f_{iZF} = 10.7 \text{ MHz}$; $R_S = 60 \Omega$; $f_m = 400 \text{ Hz}$ with $\Delta f = \pm 22.5 \text{ kHz}$; $50 \mu\text{s}$ de-emphasis ($C_{8-9} = 6.8 \text{ nF}$); $T_{amb} = 25^\circ \text{C}$ and measurements taken in Fig.1; unless otherwise specified. The demodulator circuit is adjusted at minimum second harmonic distortion with $V_{iZF} = 1 \text{ mV}$.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
IF amplifier and demodulator						
V_{iIF}	input sensitivity (RMS value; pin 17)	-3 dB before AF limiting	14	22	35	μV
	input signal for S/N = 26 dB	$f = 250 \text{ to } 15000 \text{ Hz}$	—	10	—	μV
	input signal for S/N = 46 dB	$f = 250 \text{ to } 15000 \text{ Hz}$	—	55	—	μV
V_{oAF}	output signal at pins 8 and 9 (RMS value)		60	67	75	mV
V_{oN}	noise voltage for $V_{iIF} = 0$ (RMS value; pins 8 and 9)	$R_S = 300 \Omega$; $f = 250 \text{ to } 15000 \text{ Hz}$	—	900	—	μV
	weighted noise voltage	in accordance with "DIN 45405"	—	2	—	mV
S/N	signal-to-noise ratio (pins 8 and 9)	$V_{iIF} = 1 \text{ mV}$ (RMS); see Fig.3	—	72	—	dB
α_{AM}	AM suppression	$V_{iIF} = 0.5 \text{ to } 200 \text{ mV};$ FM: $70 \text{ Hz}; \pm 15 \text{ kHz}$; AM: $1 \text{ kHz}; m = 30\%$	—	50	—	dB
α_{FM}	FM rejection for FM-off	$V_{iIF} = 500 \text{ mV}; V_5 = 3 \text{ V}$	80	—	—	dB
$\Delta V_{8,9}$	AFC shift in relation to minimum second harmonic distortion α_{2H}	$V_{iIF} = 0.03 \text{ to } 500 \text{ mV}$	—	25	—	mV
	DC offset at second harmonic distortion	operating	—	0	± 100	mV
		mute or FM-off	—	0	± 50	mV
α_{3H}	distortion for third harmonic		—	0.65	—	%
RR	ripple rejection $V_{ripple} = 200 \text{ mV}$ on V_P	$f = 100 \text{ Hz}$	43	48	—	dB

FM-IF amplifier/demodulator circuit

TDA1576T

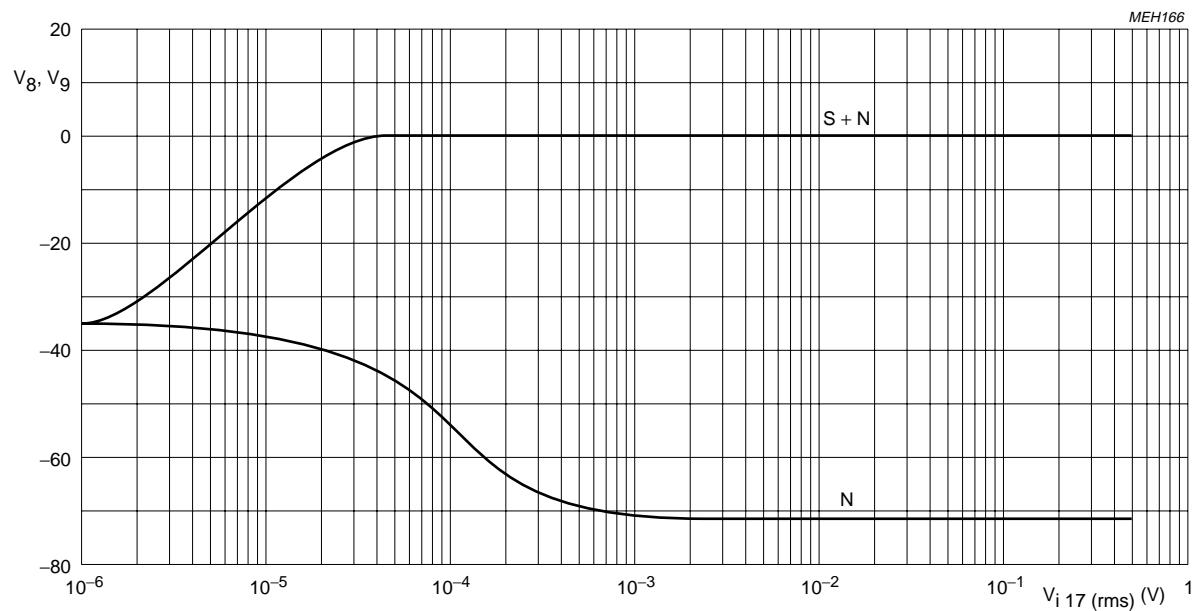


Fig.3 AF output voltage level on pins 8 and 9 as a function of $V_{i\text{IF}}$ at $V_P = 8.5$ V; $f_m = 1$ kHz; $Q_L = 20$ with de-emphasis. S = signal; N = noise.

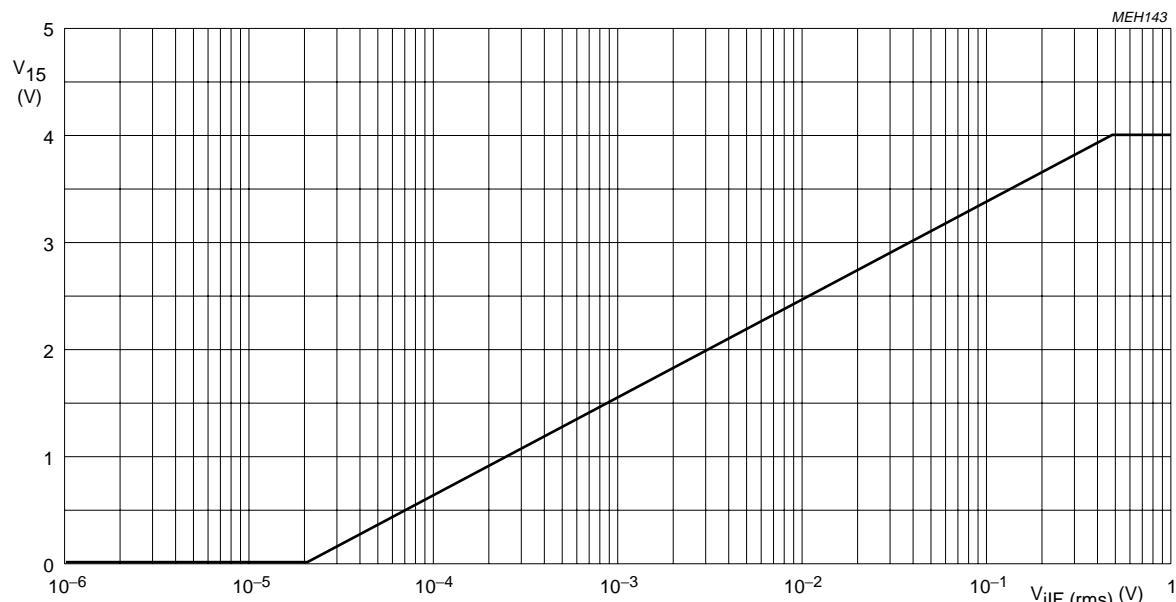


Fig.4 Field-strength output ($I_{16} = 0$).

FM-IF amplifier/demodulator circuit

TDA1576T

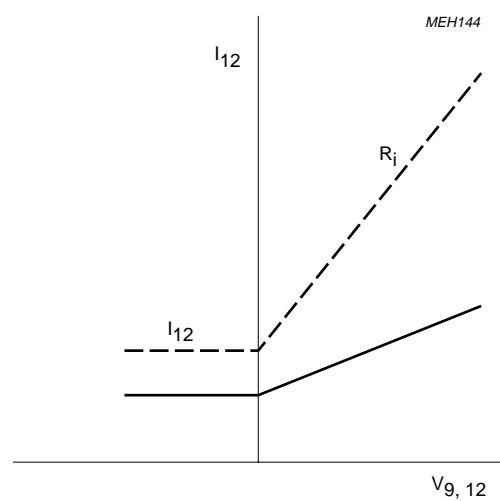


Fig.5 Detuning input impedance.

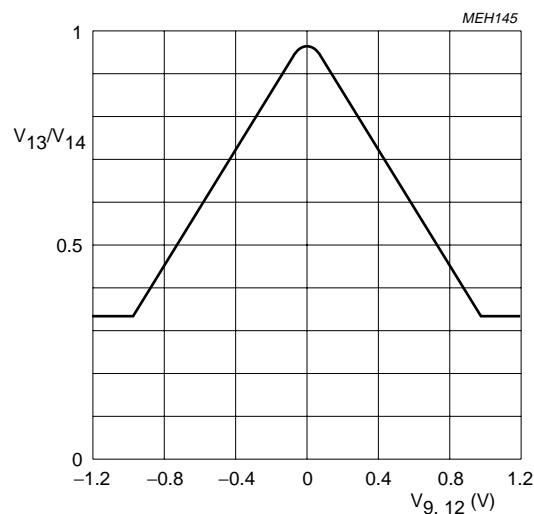


Fig.6 Detuning curve.

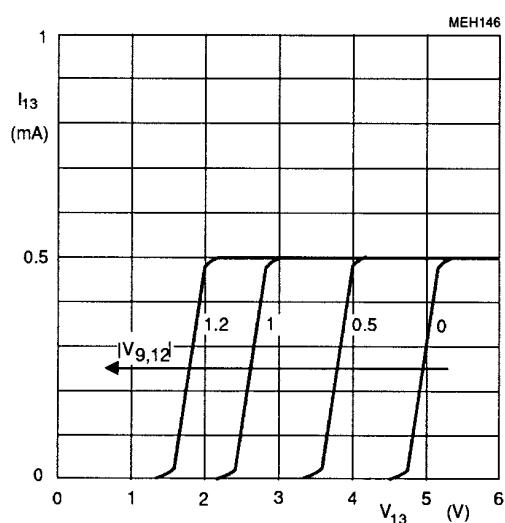


Fig.7 Detuning output.

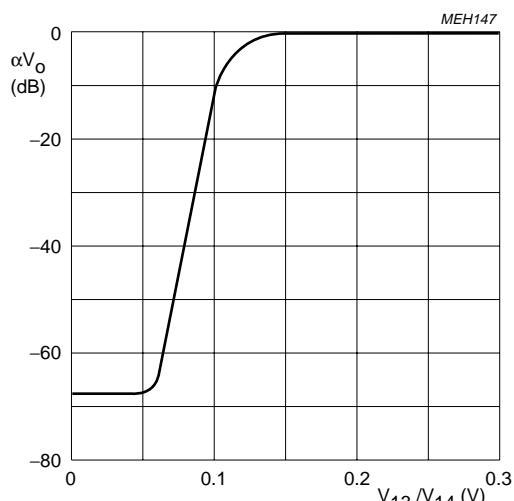


Fig.8 Internal audio attenuation.

FM-IF amplifier/demodulator circuit

TDA1576T

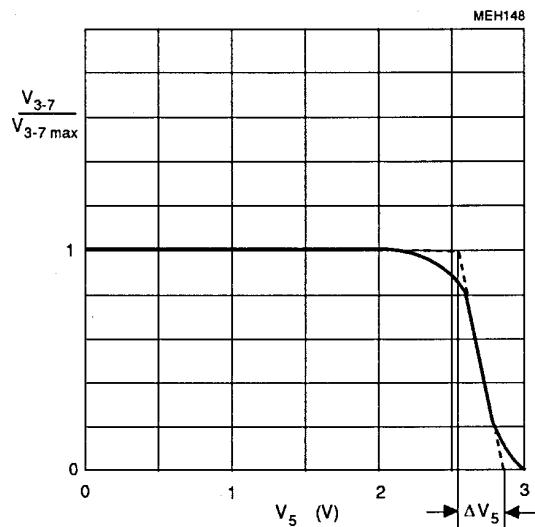


Fig.9 Standby switch.

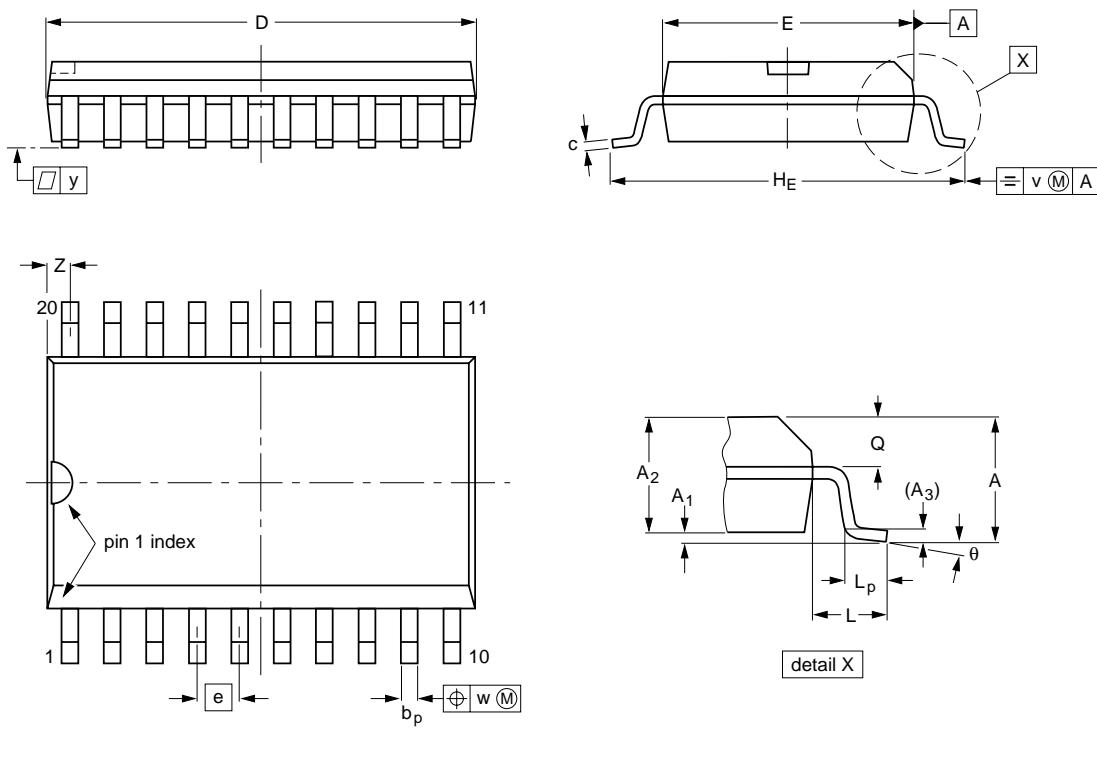
FM-IF amplifier/demodulator circuit

TDA1576T

PACKAGE OUTLINE

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.65 0.10	0.30 2.25	2.45	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10 0.004	0.012 0.089	0.096	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

- Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				-95-01-24 97-05-22

FM-IF amplifier/demodulator circuit

TDA1576T

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

Reflow soldering

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

Wave soldering

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Repairing soldered joints

Fix the component by first soldering two diagonally-opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

FM-IF amplifier/demodulator circuit**TDA1576T****DEFINITIONS**

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

FM-IF amplifier/demodulator circuit

TDA1576T

NOTES

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TDA1576T

NOTES

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